



US00D732483S

(12) **United States Design Patent**
Min et al.

(10) **Patent No.:** **US D732,483 S**
(45) **Date of Patent:** **** Jun. 23, 2015**

(54) **SOCKET MODULE FOR AN ELECTRONIC RELAY**

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(**) Term: **14 Years**

(21) Appl. No.: **29/479,564**

(22) Filed: **Jan. 17, 2014**

Related U.S. Application Data

(62) Division of application No. 29/444,530, filed on Jan.
31, 2013, now Pat. No. Des. 700,897.

(30) **Foreign Application Priority Data**

Jul. 31, 2012 (EM) 002081927

(51) **LOC (10) Cl.** **13-03**

(52) **U.S. Cl.**
USPC **D13/159**

(58) **Field of Classification Search**

USPC D13/101, 103, 110, 119, 123, 146, 147,
D13/151, 158–164, 171, 173, 174, 177, 178,
D13/184, 199; D14/240, 433, 434; 200/237,
200/293, 294, 297, 302.3, 400, 401;
361/160, 166, 601, 622, 627, 628, 686;
439/271, 535, 639, 652, 709, 715–718,
439/736

CPC F24D 19/1096; G05B 19/042; G05B
19/0426; G05B 19/23043; G05B 2219/23051;
G05B 2219/23297; G05B 2219/23406; G05B
19/25085; G05B 19/2625; H01H 35/027;
H01H 19/64; H01H 1/365; H01H 2071/0292;

H01H 21/54; H01H 71/0271; H05B 1/0277;
H05B 2203/032; H01R 4/36; H01R 4/4827;
H01R 9/2491; H01R 9/26; H01R 9/2658;
H01R 13/447; H01R 13/50; H01R 13/501;
H01R 29/00; H01R 31/08; H01R 4/2433

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a socket module for an electronic
relay, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of a socket module for an elec-
tronic relay in accordance with our new design as seen from
the right front;

FIG. 2 is a front elevation view thereof;

FIG. 3 is a rear elevation view thereof;

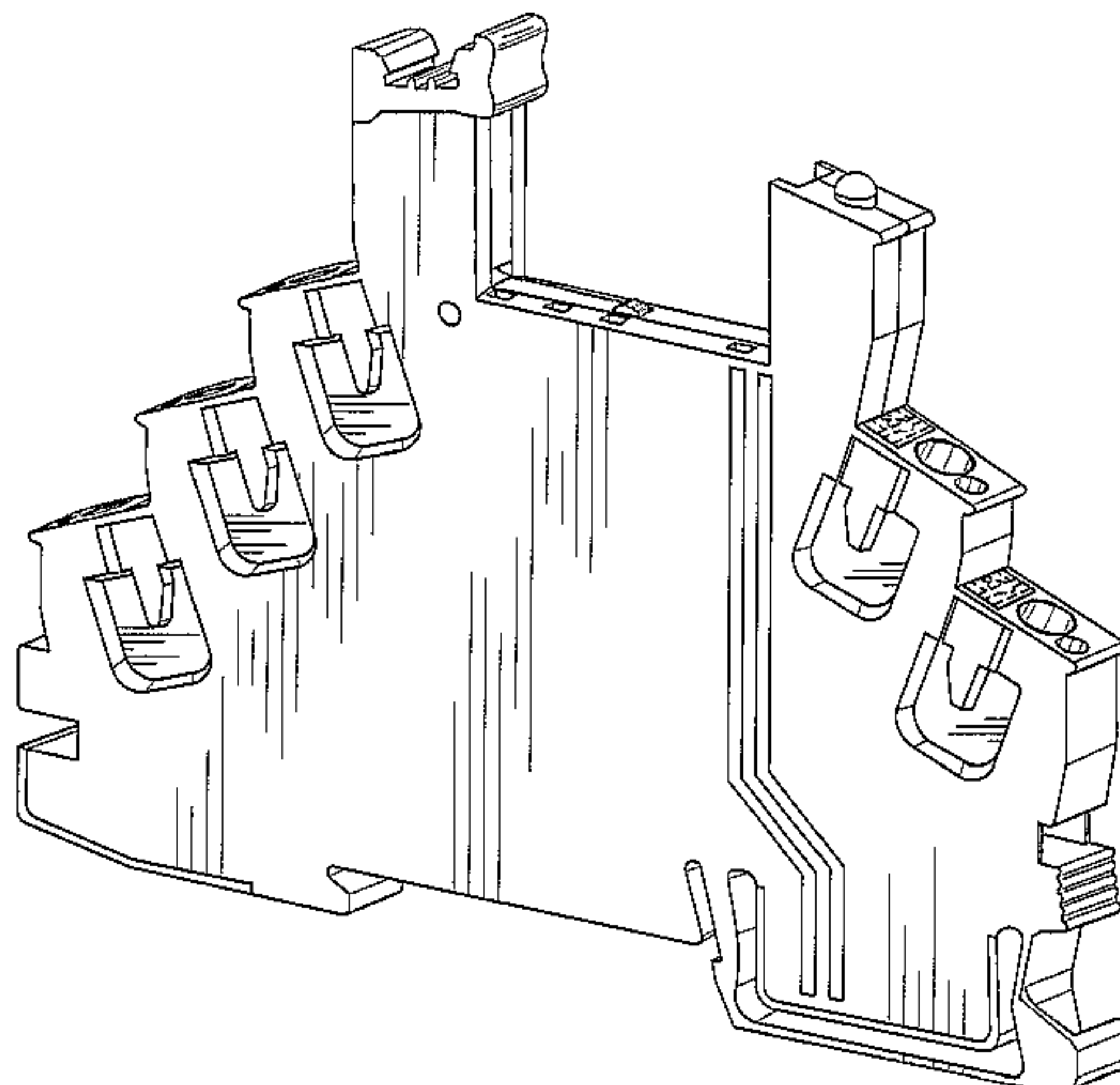
FIG. 4 is a right side elevation view thereof;

FIG. 5 is a left side elevation view thereof; and,

FIG. 6 is a top plan view thereof.

The broken line portion of the figure drawings is included to
show unclaimed subject matter only and forms no part of the
claimed design.

1 Claim, 3 Drawing Sheets



(56)

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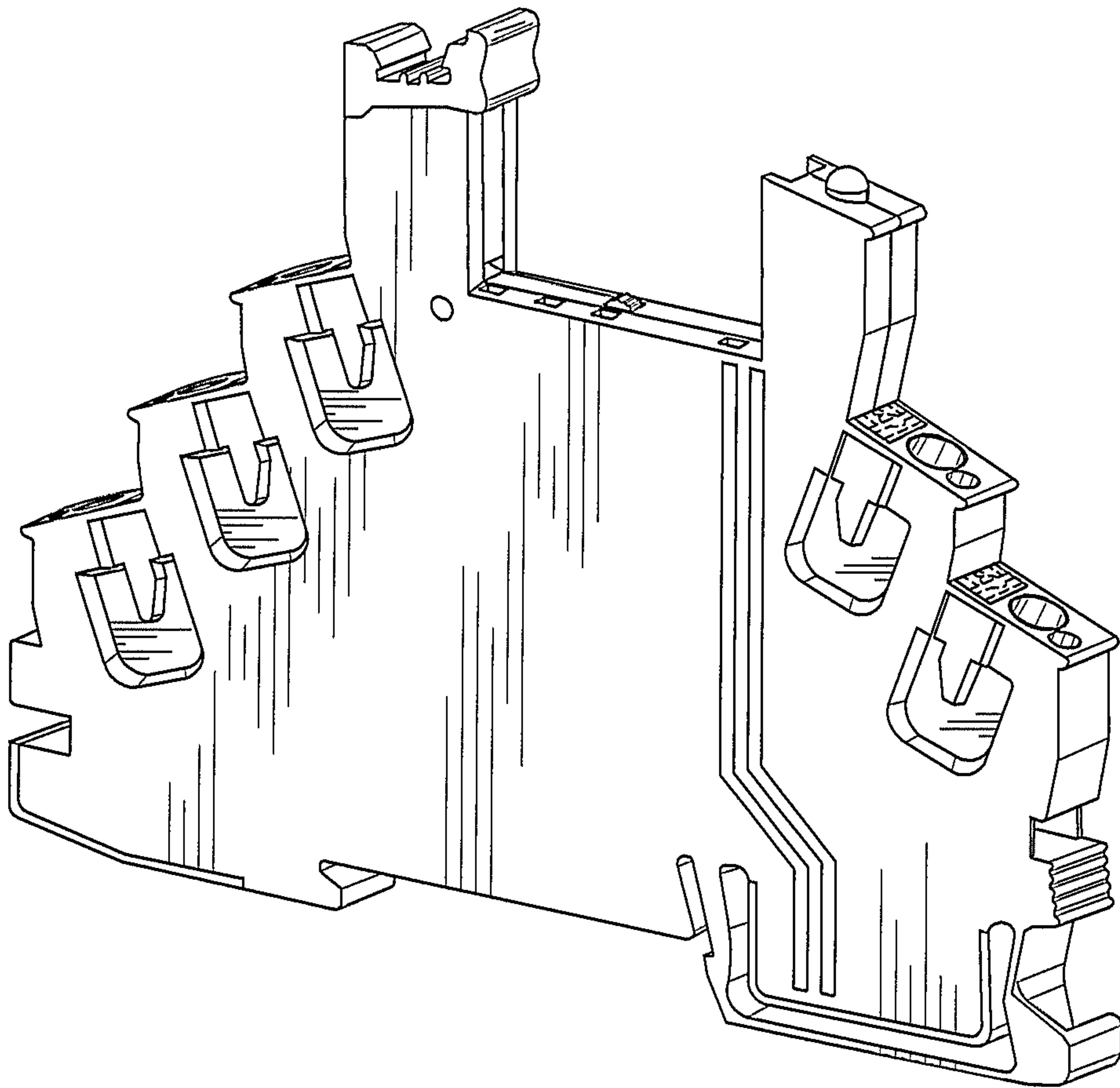


FIG. 1

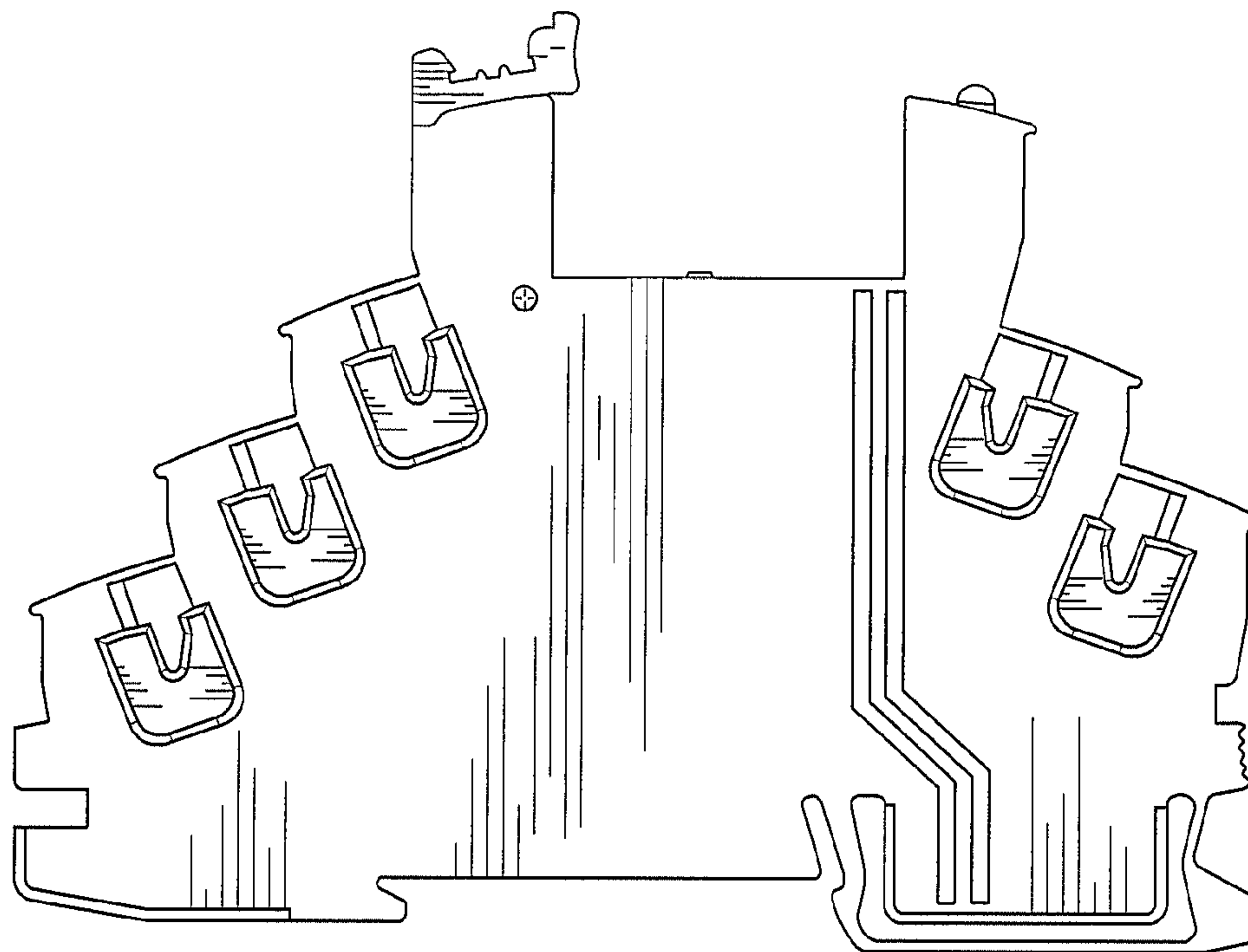


FIG. 2

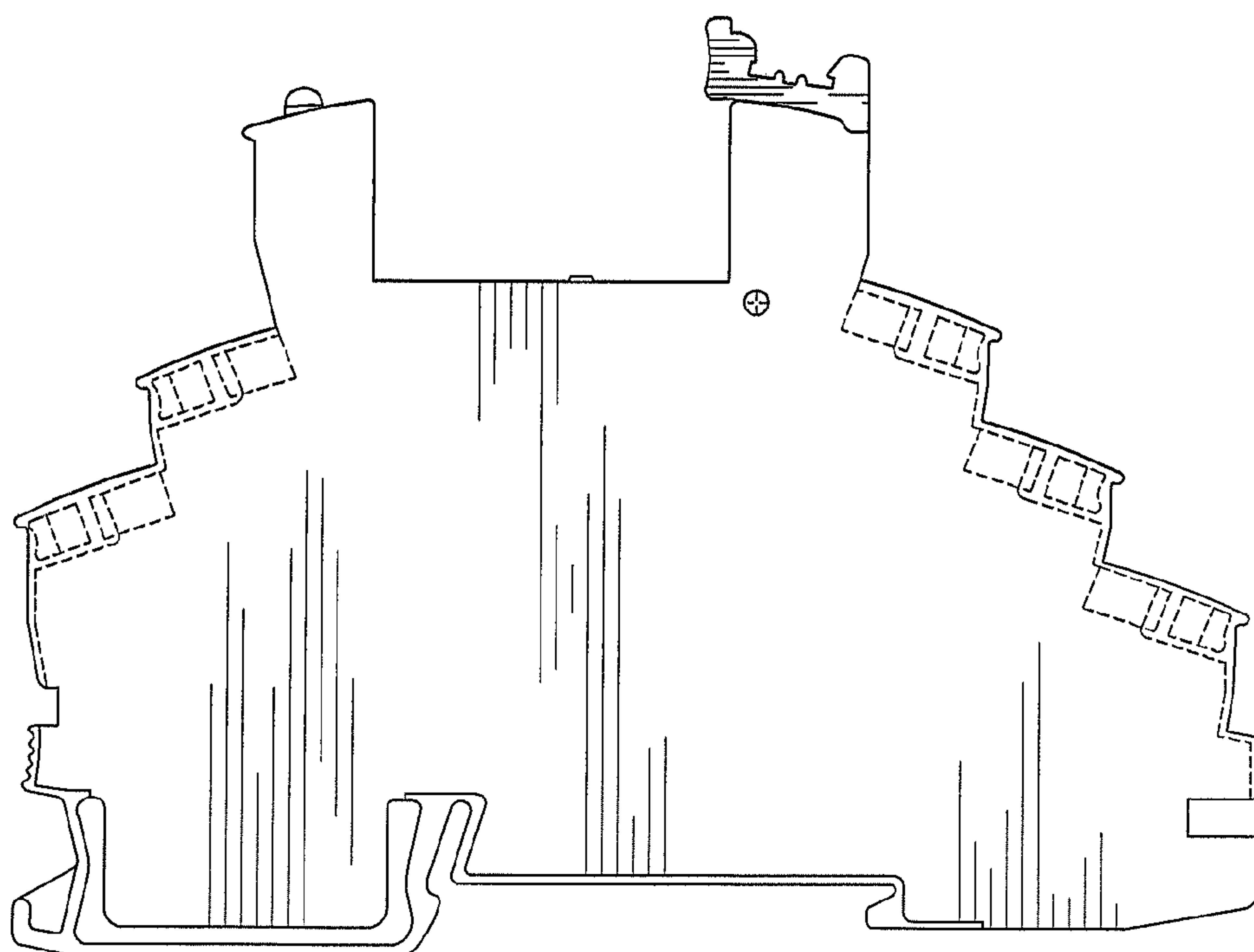


FIG. 3

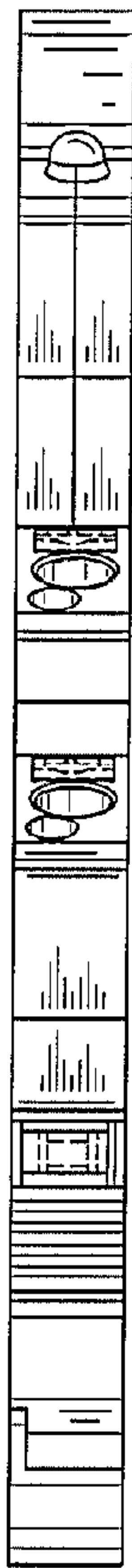


FIG. 4

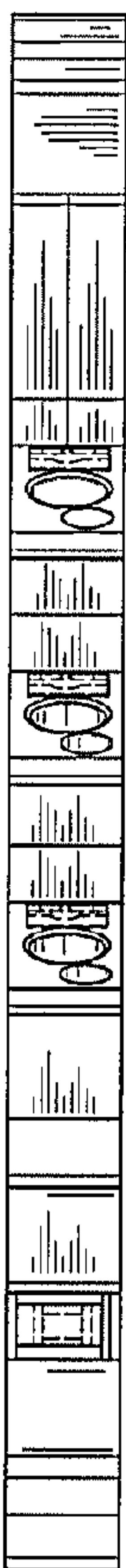


FIG. 5

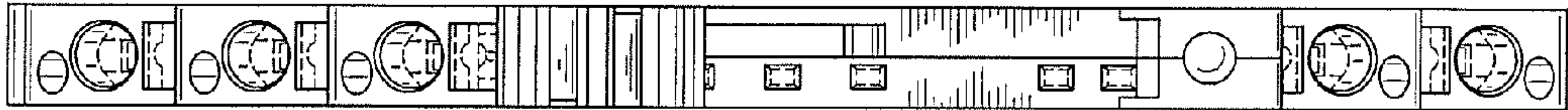


FIG. 6